

About KEN FOUNDATION's Scholarship Programme

KEN FOUNDATION was formed in 1995 as a charitable foundation with the objective of providing financial assistance to deserving Malaysian students. We believe that a sound educational background is the root to a nation's success, and we are committed to fulfilling this goal by offering scholarships to as many deserving Malaysian students as we can. Our policy does not seek academic excellence but is most concerned in assisting needy and able Malaysian students. By helping these students, we believe we could groom even more capable Malaysians for the future and offer them greater options in life.

FIELD OF STUDY

- Civil Engineering
- Quantity Surveying
- Architecture
- Building Management
- Business Administration/Marketing/Communication/Accounting
- Human Resource Management
- Event Management
- Hospitality / Hotel Management
- Agriculture

ELIGIBILITY CRITERIA

- Malaysian citizen and a full-time student between 18 – 23 years old
- Low income family (Combined level of income not exceeding RM60,000 per annum)
- Students who possess reasonably good results & have successfully been offered a course as defined in the field of study at any local universities
- Must not be bonded to or in receipt of any financial aid or rewards from other educational institutions, organisations or foundations
- Open to undergraduates and for first degree only

Value of Scholarship

RM6,000 to RM10,000 per academic year

How to Apply

To apply, please submit the following:

- Recent Passport-sized photo
- One (1) copy of the Application Form (download from www.kenholdings.com.my)
- Copy of applicant's Identification Card (front and back)
- Copy of the applicant's University acceptance letter*
- Copy of latest Income Tax Return, EA Form, Borang B, payslips of parents/guardian(s) and siblings (if any)*
- Copies of academic results, certificates and transcripts*
- Copy of the applicant's academic award certificates / achievements and participation in co-curricular activities*

* Applicants need to produce original copies during the interview should he or she been shortlisted

** A bond period is attached to the scholarship

Closing date: 5 August 2022